



## Material Content Data Sheet



<b>Sales Product Name</b>		BTS7008-1EPP		<b>Issued</b>		4. July 2019		
<b>MA#</b>		MA002936772						
<b>Package</b>		PG-TSDSO-14-22		<b>Weight*</b>		64.90 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	0.856	1.32	1.32	13187	13187
leadframe	inorganic material	phosphorus	7723-14-0	0.009	0.01		145	
	non noble metal	zinc	7440-66-6	0.038	0.06		581	
	non noble metal	iron	7439-89-6	0.754	1.16		11618	
wire	non noble metal	copper	7440-50-8	30.617	47.17	48.40	471740	484084
	non noble metal	copper	7440-50-8	0.470	0.72	0.72	7241	7241
encapsulation	organic material	carbon black	1333-86-4	0.088	0.14		1358	
	plastics	epoxy resin	-	3.438	5.30		52971	
	inorganic material	silicondioxide	60676-86-0	25.858	39.84	45.28	398417	452746
leadfinish	non noble metal	tin	7440-31-5	1.642	2.53	2.53	25294	25294
plating	noble metal	silver	7440-22-4	0.816	1.26	1.26	12574	12574
glue	plastics	epoxy resin	-	0.055	0.09		853	
	noble metal	silver	7440-22-4	0.261	0.40	0.49	4021	4874
*deviation	< 10%					Sum in total:	100.00	1000000

### Important Remarks:

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This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

Company	Infineon Technologies AG
Address	81726 München
Internet	www.infineon.com